NSN 5962-01-079-2293

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-01-079-2293 **Body Length:** Between 1.386 inches and 1.425 inches **Body Width:** Between 0.510 inches and 0.598 inches **Body Height:** Between 0.142 inches and 0.158 inches **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Monolithic and hermetically sealed and negative outputs and w/enable and w/buffered output and w/decoded output **Inclosure Material:** Ceramic and glass **Inclosure Configuration:** Dual-in-line **Output Logic Form:** P-type metal oxide-semiconductor logic **Input Circuit Pattern:** 9 input **Terminal Surface Treatment:** Solder **Voltage Rating And Type Per Characteristic:** -35.0 volts power source and 0.3 volts power source **Time Rating Per Chacteristic:** 20.00 nanoseconds propagation delay time, low to high level output **Memory Device Type:** Rom **Test Data Document:** 13499-351-8428 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 28 printed circuit Shelf Life: N/a **Unit Of Measure:**

Demilitarization: Yes - demil/mli

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